

Electronic Patent Application Fee Transmittal

Application Number:	10516602			
Filing Date:	05-Jul-2005			
Title of Invention:	Method of forming a metal pattern and a method of fabricating tft array panel by using the same			
First Named Inventor/Applicant Name:	Hong-Sick Park			
Filer:	Frank Chau/Scott Appelbaum			
Attorney Docket Number:	8071-152T			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	790	790
Total in USD (\$)				790